

Thyristor/Thyristor (Super MAGN-A-PAK Power Modules), 570 A



Super MAGN-A-PAK

PRIMARY CHARACTERISTICS				
I _{T(AV)}	570 A			
Туре	Modules - thyristor, standard			
Package	Super MAGN-A-PAK			

FEATURES

- · High current capability
- High surge capability
- · Industrial standard package
- 3000 V_{RMS} isolating voltage with non-toxic substrate
- · Designed and qualified for industrial level
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- Motor starters
- DC motor controls AC motor controls
- Uninterruptible power supplies

MAJOR RATING	MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{T(AV)}	T _C = 74 °C	570				
I _{T(RMS)}	T _C = 74 °C	895	A			
I _{TSM}	50 Hz	17 800	^			
	60 Hz	18 700				
l ² t	50 Hz	1591	kA ² s			
1-1	60 Hz 1452		KA ² S			
I ² √t		15 910	kA ^{2√} s			
V _{RRM}	Range	1800	V			
T _{Stg}	Range	-40 to +135	°C			
T _J	Range	-40 to +135				

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS						
TYPE NUMBER	VOLTAGE CODE	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$\begin{aligned} I_{RRM}/I_{DRM} & \text{MAXIMUM} \\ \text{AT T}_{J} &= T_{J} & \text{MAXIMUM} \\ & \text{mA} \end{aligned}$		
VS-VSKT570-18PbF	18	1800	1900	120		



ON-STATE CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current		190° conduction	on, half sine wave		570 74	Α
at case temperature	I _{T(AV)}	180 Conduction	on, nan sine wave			°C
Maximum RMS on-state current	I _{T(RMS)}	180° conduction	on, half sine wave	at T _C = 74 °C	895	Α
		t = 10 ms	No voltage		17.8	
Maximum peak, one-cycle,	I _{TSM,}	t = 8.3 ms	reapplied		18.7	kA kA ² s
non-repetitive on-state surge current	I _{FSM}	t = 10 ms	100 % V _{RRM}		15.0	
		t = 8.3 ms	reapplied	Sinusoidal	15.7	
Mariana 24 fau faoina		t = 10 ms	No voltage reapplied		1591	
	l ² t	t = 8.3 ms			1452	
Maximum I ² t for fusing		t = 10 ms	100 % V _{RRM}		1125	
		t = 8.3 ms	reapplied		1027	
Maximum $I^2\sqrt{t}$ for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied		eapplied	15 910	kA²√s
Low level value or threshold voltage	V _{T(TO)1}	(16.7 % x π x I	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum		0.864	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			v
Low level value on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum			0.411	mΩ
High level value on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		0.362	11152	
Maximum on-state voltage drop	V_{TM}	$I_{pk} = 1500 \text{ A}, T_J = 25 \text{ °C}, t_p = 10 \text{ ms sine pulse}$			1.50	V
Maximum holding current	I _H	T _ 05 °C	ada aupply 10 V za	opiotivo lood	500	mΛ
Maximum latching current	ΙL	1j = 25 C, and	ode supply 12 V re	ssistive load	1000	- mA

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum rate of rise of turned-on current	dl/dt	$T_J = T_J$ maximum, $I_{TM} = 400$ A, V_{DRM} applied	1000	A/µs	
Typical delay time	t _d	Gate current 1 A, $dI_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}$, $T_J = 25 °C$	2.0		
Typical turn-off time	t _q	I_{TM} = 750 A; T_J = T_J maximum, dl/dt = - 60 A/μs, V_R = 50 V, dV/dt = 20 V/μs, gate 0 V 100 Ω	200	μs	

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, linear to $V_D = 80 \% V_{DRM}$	1000	V/µs
RMS insulation voltage	V _{INS}	t = 1 s	3000	V
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	120	mA



TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P_{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms	10	W	
Maximum peak average gate power	P _{G(AV)}	$T_J = T_J$ maximum, f = 50 Hz, d % = 50	2.0] vv	
Maximum peak positive gate current	+l _{GM}		3.0	Α	
Maximum peak positive gate voltage	+V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms	20	V	
Maximum peak negative gate voltage	-V _{GM}		5.0		
Maximum DC gate current required to trigger	I _{GT}	T - 25 °C V 12 V	200	mA	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C, V _{ak} 12 V	3.0	V	
DC gate current not to trigger	I_{GD}	$T_J = T_J$ maximum	10	mA	
DC gate voltage not to trigger	V_{GD}		0.25	V	

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction operating temperature range	TJ		-40 to +135	°C
Maximum storage temperature range	T _{Stg}		-40 to +135	
Maximum thermal resistance, junction to case per junction	R _{thJC}	DC operation	0.065	14004
Maximum thermal resistance, case to heatsink per module	R _{thC-hs}	Mounting surface smooth, flat and greased	0.02 K/W	
Mounting Super MAGN-A-PAK to heatsing	nk	A mounting compound is recommended and the torque should be rechecked after a period	6 to 8	Nm
torque busbar to super MAGN-A-PA	K	of 3 hours to allow for the spread of the compound	12 to 15	INIII
Approximate weight			1500	g
Case style		See dimensions (link at the end of datasheet)	Super MAGN-	-A-PAK

△R _{thJC} CONDUCTIO	N			
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS
180°	0.009	0.006		
120°	0.011	0.011		
90°	0.014	0.015	$T_J = T_J$ maximum	K/W
60°	0.021	0.022		
30°	0.037	0.038		

Note

• Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

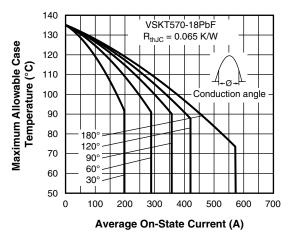


Fig. 1 - Current Ratings Characteristics

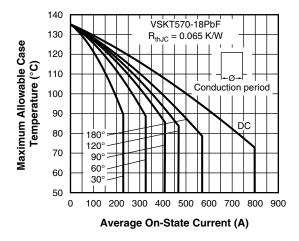


Fig. 2 - Current Ratings Characteristics

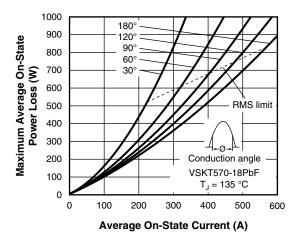


Fig. 3 - On-State Power Loss Characteristics

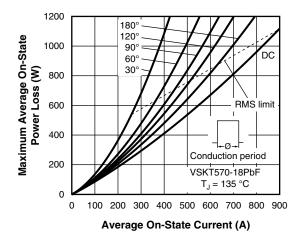


Fig. 4 - On-State Power Loss Characteristics

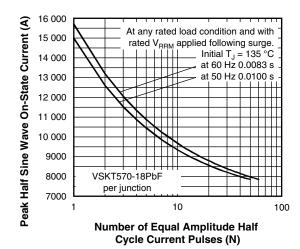


Fig. 5 - Maximum Non-Repetitive Surge Current

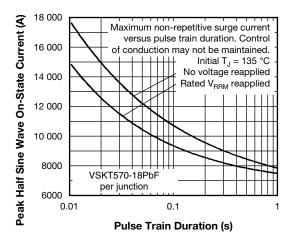
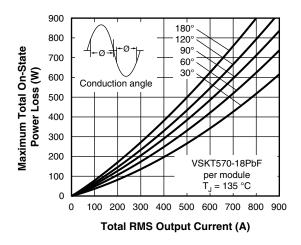


Fig. 6 - Maximum Non-Repetitive Surge Current



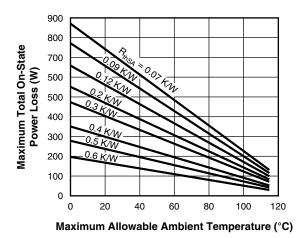


Fig. 7 - On-State Power Loss Characteristics

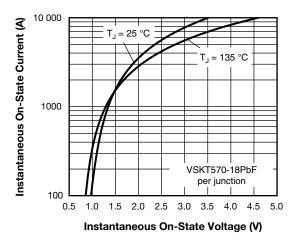


Fig. 8 - On-State Voltage Drop Characteristics

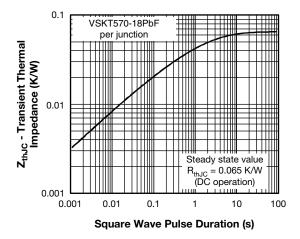


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

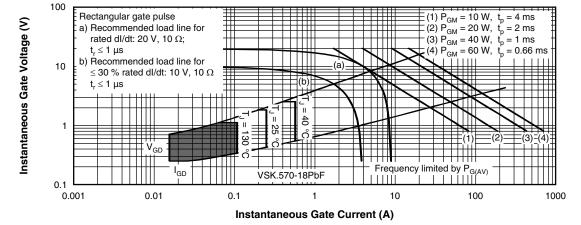
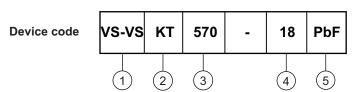


Fig. 10 - Gate Characteristics

ORDERING INFORMATION TABLE



1 - Vishay Semiconductors product

- Circuit configuration (see below)

Current rating

Voltage code x 100 = V_{RRM}

5 - Lead (Pb)-free

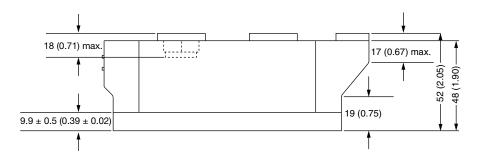
CIRCUIT CONFIGURATION				
CIRCUIT DESCRIPTION	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING		
Two SCRs doubler circuit	KT	VSKT 1 0 4 (K1) 7 (K2) 0 5 (G1) 6 (G2)		

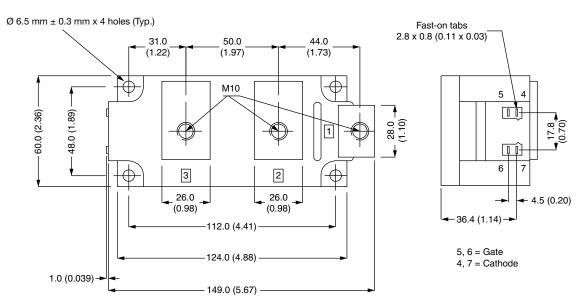
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95283



Super MAGN-A-PAK Thyristor/Diode

DIMENSIONS in millimeters (inches)





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